

TEMASEK

SGX RELEASE

Temasek redeems S\$500 million 2.70% Temasek Bond due 2023

Singapore, 25 October 2023 – Temasek Holdings (Private) Limited (“Temasek”) has redeemed its S\$500 million 2.70% Guaranteed Notes due 2023 (“T2023-S\$ Temasek Bond”), issued through its wholly-owned subsidiary, Temasek Financial (IV) Private Limited (“TFin-IV”).

The T2023-S\$ Temasek Bond had an issue size of S\$500 million and a coupon of 2.70% per annum.

The T2023-S\$ Temasek Bond was issued five years ago in October 2018 by TFin-IV under Temasek’s S\$5 billion Guaranteed Medium Term Note (MTN) Programme, and guaranteed by Temasek.

On its maturity date of 25 October 2023, the T2023-S\$ Temasek Bond was redeemed at par and cancelled in accordance with its terms.

With the redemption of the T2023-S\$ Temasek Bond, Temasek has 22 series of outstanding Temasek Bonds, seven of which are denominated in Singapore dollars.

Temasek would like to thank investors for their confidence and support in its T2023-S\$ Temasek Bond.

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References to “S\$” refer to Singapore dollars, the lawful currency of Singapore.

Contact Us

For general enquiries, please contact us at bond@temasek.com.sg

For media queries, please contact:

Kelvin NG

Vice President, Public Affairs, Temasek

Tel: +65 6828 6939

Email: kelvinng@temasek.com.sg

For investor queries, please contact:

CHONG Hui Min

Director, Investor Relations, Temasek

Tel: +65 6828 2468

Email: huimin@temasek.com.sg